

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Classification::
Suggested Group Art Unit::
CD-ROM or CD_R?:: None
Number of CD disks::
Number of copies of CDs::
Sequence Submission:: No
Computer Readable Form (CRF)?:: No
Title:: SEMICONDUCTOR DEVICE WITH DRAM INSIDE
Attorney Docket Number:: 10873.1244US01
Request For Early Publication:: No
Request For Non-Publication:: No
Suggested Drawing Figure:: 1A
Total Drawing Sheets:: 5
Small Entity:: No
Latin Name::
Variety Denomination Name::
Petition Included:: No
Petition Type::
Licensed US Govt. Agency::
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

Initial 07/18/03

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takashi
Middle Name::
Family Name:: NAKABAYASHI
Name Suffix::
City of Residence:: Hirakata-shi
State or Province of Residence::
Country of Residence:: Japan
Street of mailing address:: 3-13-1-306, Oogaito-cho
City of mailing address:: Hirakata-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 573-0027

Correspondence Information

Correspondence Customer Number:: 23552

Representative Information

Representative Customer Number::	23552
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Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-230478	08/07/03	Yes

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Assignee Information

Assignee Name:: Matsushita Electric Industrial Co., Ltd.
Street of mailing address:: 1006, Oaza Kadoma
City of mailing address:: Kadoma-shi
State or Province of mailing address:: Osaka
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 571-8501

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